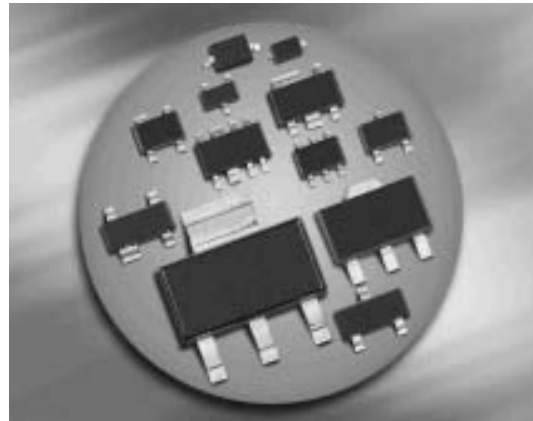
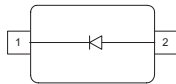
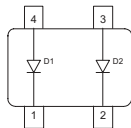
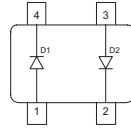
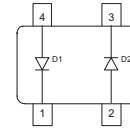


Silicon Deep Trench PIN Diodes

- Optimized for low bias current antenna switches in hand held applications
- Very low capacitance at zero volt reverse bias at frequencies above 1GHz (typ. 0.19pF)
- Low forward resistance (typ. 1.3Ω @ $I_F = 3\text{mA}$)
- Improved ON / OFF mode harmonic distortion balance


BAR90-02L
BAR90-02LRH

BAR90-07L4
BAR90-07LRH

BAR90-098L4
BAR90-098LRH

BAR90-099L4
BAR90-099LRH


Type	Package	Configuration	L_S (nH)	Marking
BAR90-02L*	TSLP-2-1	single, leadless	0.4	RT
BAR90-02LRH*	TSLP-2-7	single, leadless	0.4	R9
BAR90-07L4*	TSLP-4-4	parallel pair, leadless	0.4	RT
BAR90-07LRH*	TSLP-4-7	parallel pair, leadless	0.4	T
BAR90-098L4*	TSLP-4-4	anti-parallel pair, leadless	0.4	TT
BAR90-098LRH*	TSLP-4-7	anti-parallel pair, leadless	0.4	T9
BAR90-099L4*	TSLP-4-4	anti-parallel pair, leadless	0.4	TR
BAR90-099LRH*	TSLP-4-7	anti-parallel pair, leadless	0.4	99

* Preliminary data

Maximum Ratings at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value	Unit
Diode reverse voltage	V_R	80	V
Forward current	I_F	100	mA
Total power dissipation $T_S \leq 133^\circ\text{C}$	P_{tot}	250	mW
Junction temperature	T_J	150	°C
Operating temperature range	T_{op}	-55 ... 125	
Storage temperature	T_{stg}	-55 ... 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R_{thJS}	≤ 65	K/W

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

DC Characteristics

Breakdown voltage $I_{(BR)} = 5 \mu\text{A}$	$V_{(BR)}$	80	-	-	V
Reverse current $V_R = 60 \text{ V}$	I_R	-	-	50	nA
Forward voltage $I_F = 3 \text{ mA}$ $I_F = 100 \text{ mA}$	V_F	0.75 -	0.81 0.9	0.87 1	V

¹⁾For calculation of R_{thJA} please refer to Application Note Thermal Resistance

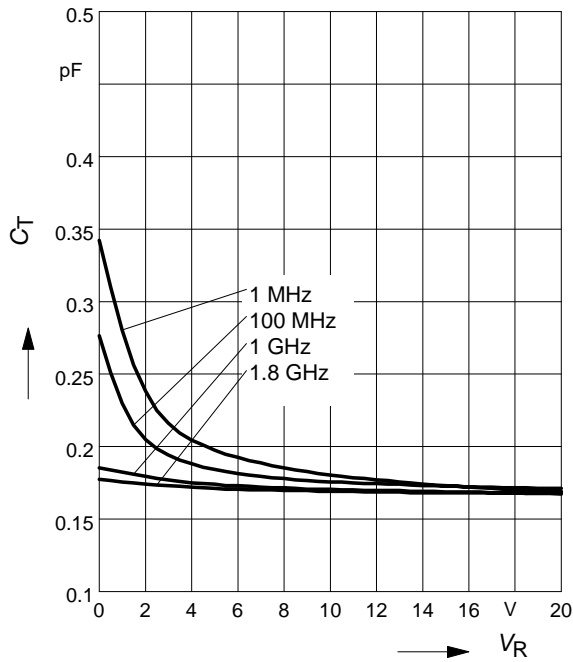
Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics					
Diode capacitance $V_R = 1\text{ V}, f = 1\text{ MHz}$ $V_R = 0\text{ V}, f = 100\text{ MHz}$ $V_R = 0\text{ V}, f = 1\text{ GHz}$ $V_R = 0\text{ V}, f = 1.8\text{ GHz}$	C_T	-	0.25 0.3 0.19 0.18	0.35 - - -	pF
Reverse parallel resistance $V_R = 0\text{ V}, f = 100\text{ MHz}$ $V_R = 0\text{ V}, f = 1\text{ GHz}$ $V_R = 0\text{ V}, f = 1.8\text{ GHz}$	R_p	-	35 5 4	- - -	k Ω
Forward resistance $I_F = 1\text{ mA}, f = 100\text{ MHz}$ $I_F = 3\text{ mA}, f = 100\text{ MHz}$ $I_F = 10\text{ mA}, f = 100\text{ MHz}$	r_f	-	2 1.3 0.8	- 2.3 -	Ω
Charge carrier life time $I_F = 10\text{ mA}, I_R = 6\text{ mA}$, measured at $I_R = 3\text{ mA}$, $R_L = 100\ \Omega$	τ_{rr}	-	750	-	ns
I-region width	W_I	-	20	-	μm
Insertion loss ¹⁾ $I_F = 1\text{ mA}, f = 1.8\text{ GHz}$ $I_F = 3\text{ mA}, f = 1.8\text{ GHz}$ $I_F = 10\text{ mA}, f = 1.8\text{ GHz}$	$ S_{21} ^2$	-	-0.16 -0.11 -0.08	- - -	dB
Isolation ¹⁾ $V_R = 0\text{ V}, f = 0.9\text{ GHz}$ $V_R = 0\text{ V}, f = 1.8\text{ GHz}$ $V_R = 0\text{ V}, f = 2.45\text{ GHz}$	$ S_{21} ^2$	-	-18.5 -13.5 -11.5	- - -	

¹BAR90-02L in series configuration, $Z = 50\ \Omega$

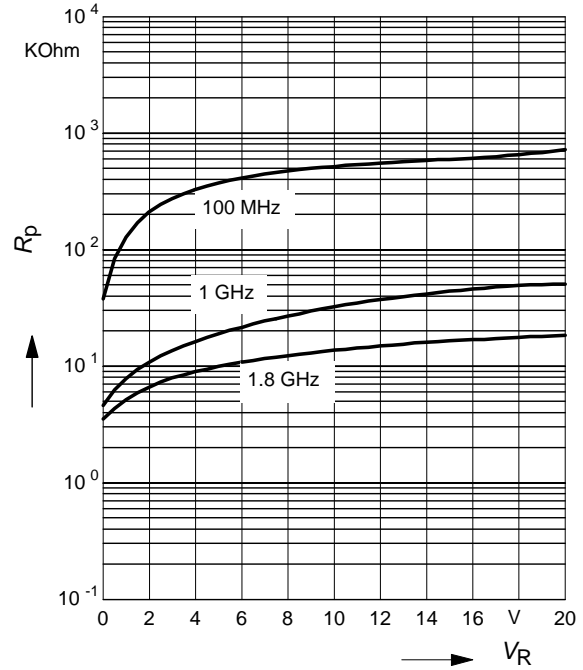
Diode capacitance $C_T = f(V_R)$

$f =$ Parameter



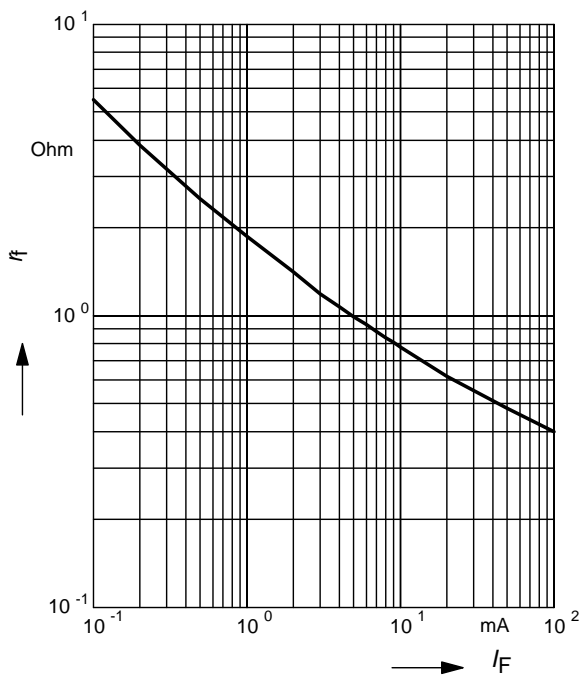
Reverse parallel resistance $R_p = f(V_R)$

$f =$ Parameter



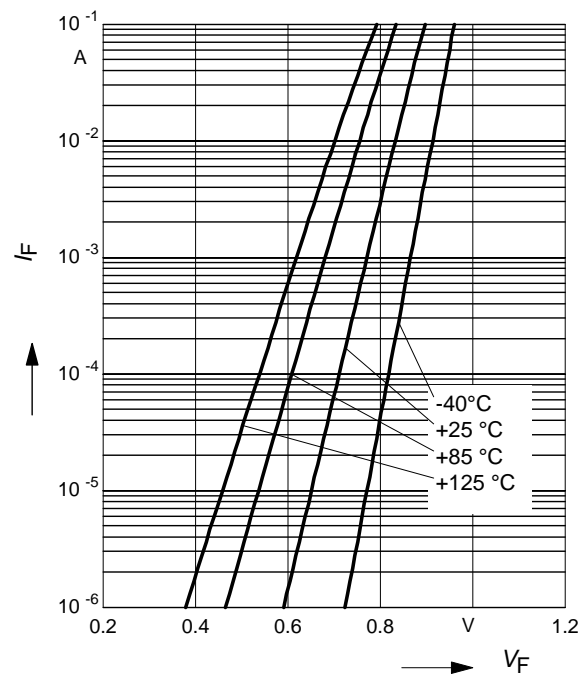
Forward resistance $r_f = f(I_F)$

$f = 100$ MHz

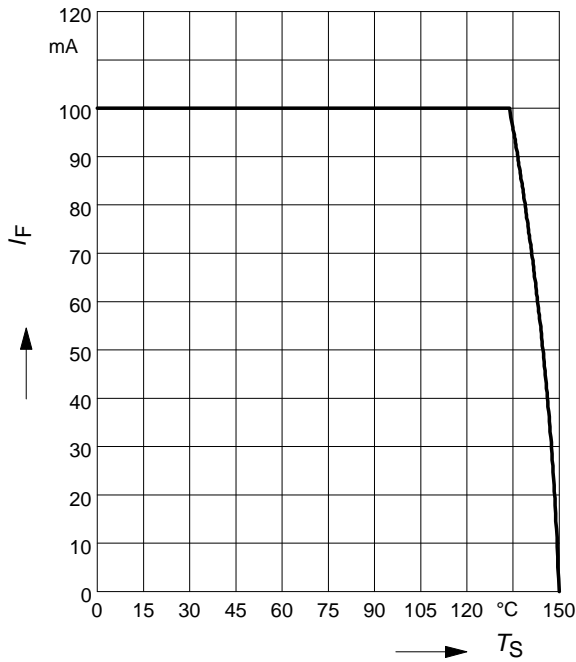


Forward current $I_F = f(V_F)$

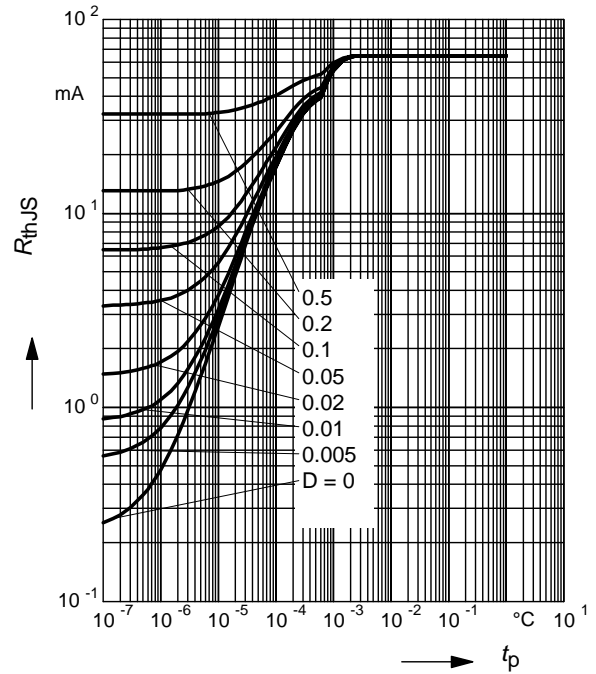
$T_A =$ Parameter



Forward current $I_F = f(T_S)$

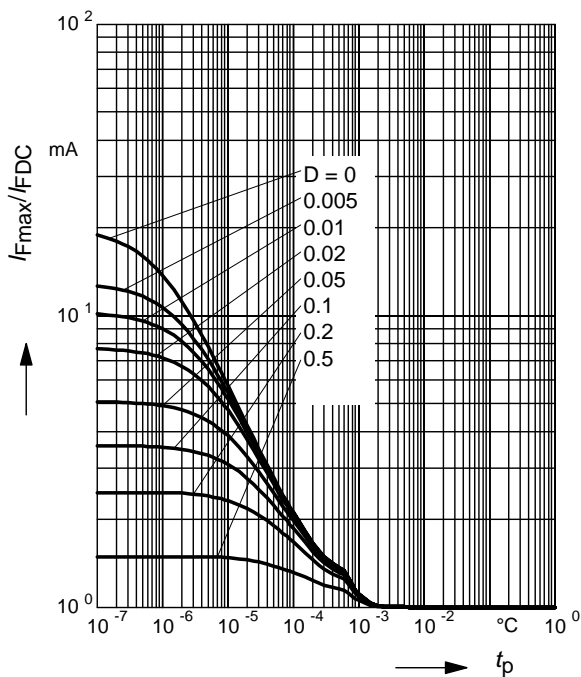


Permissible Puls Load $R_{thJS} = f(t_p)$



Permissible Pulse Load

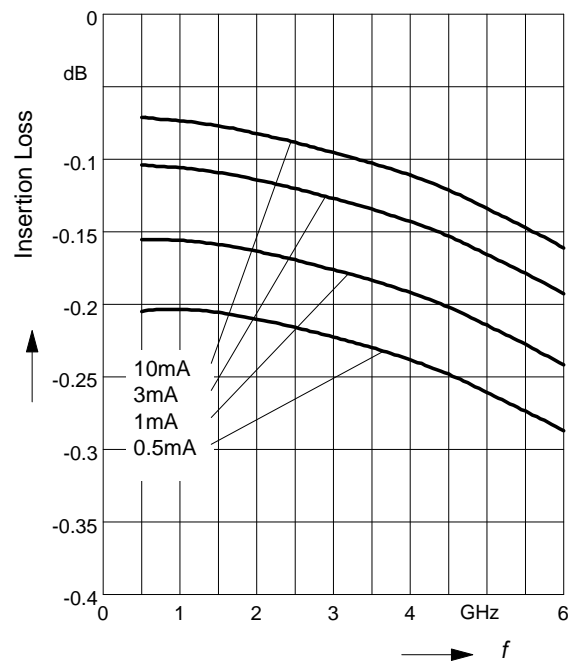
$I_{Fmax} / I_{FDC} = f(t_p)$



Insertion loss $|S_{21}|^2 = f(f)$

I_F = Parameter

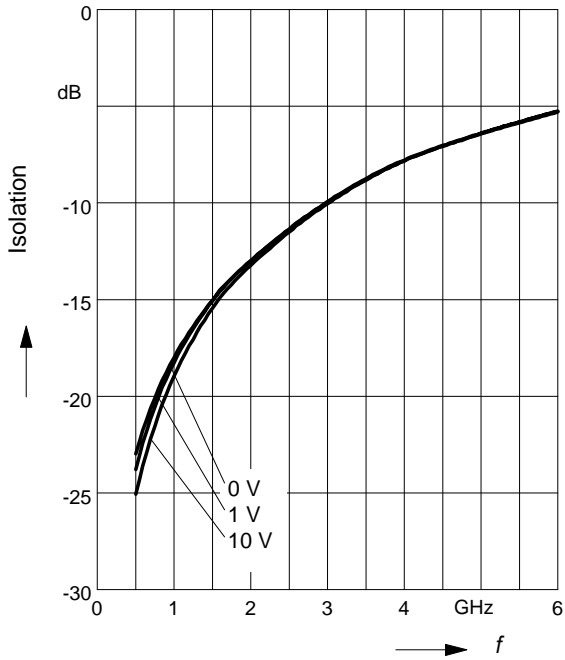
BAR90-02L in series configuration, $Z = 50\Omega$



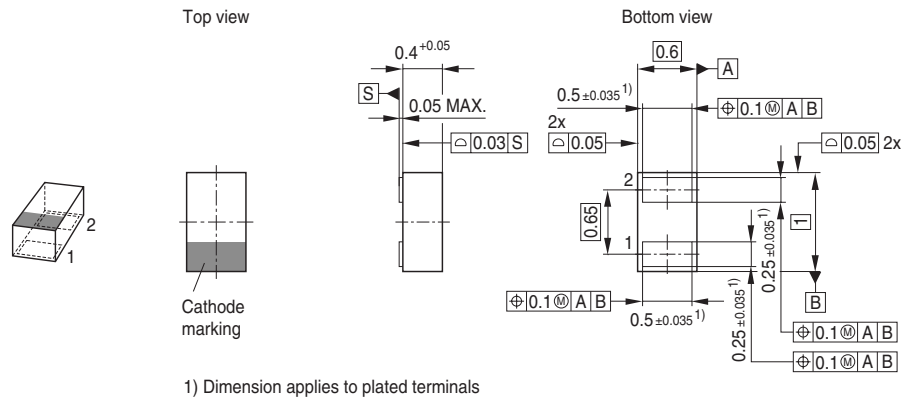
Isolation $|S_{21}|^2 = f(f)$

V_R = Parameter

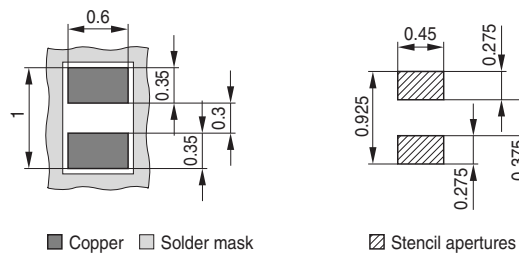
BAR90-02L in series configuration, $Z = 50\Omega$



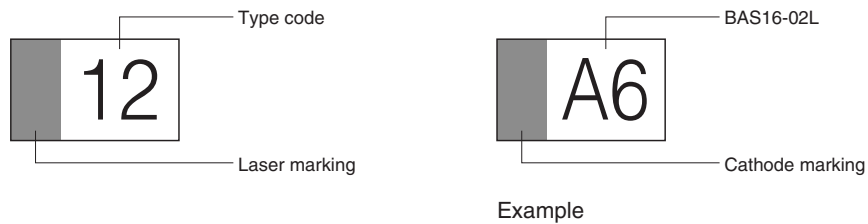
Package Outline



Foot Print

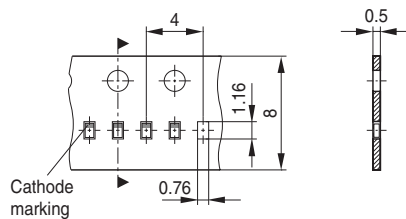


Marking Layout

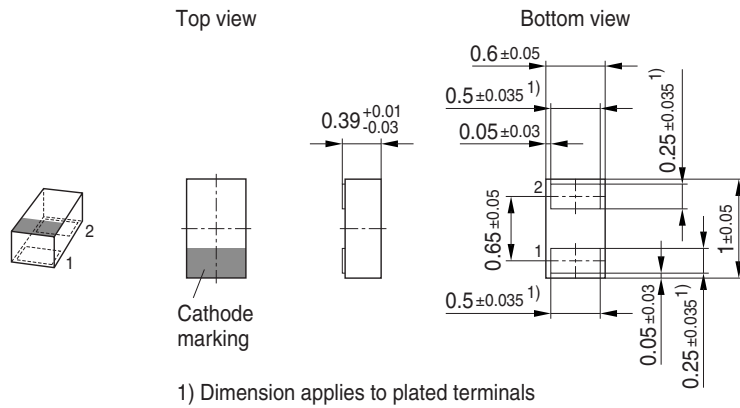


Packing

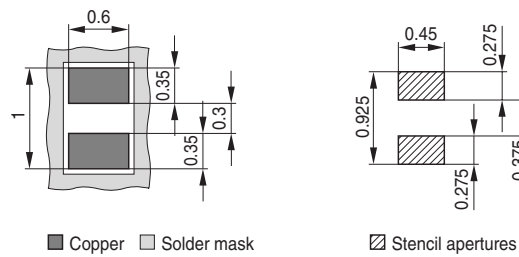
Code E6327: Reel ø180 mm = 15.000 Pieces/Reel



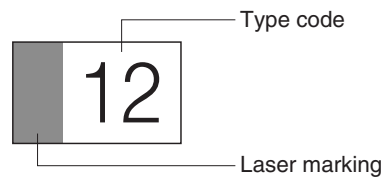
Package Outline



Foot Print

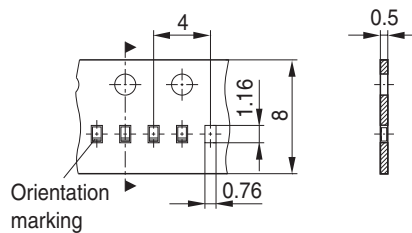


Marking Layout

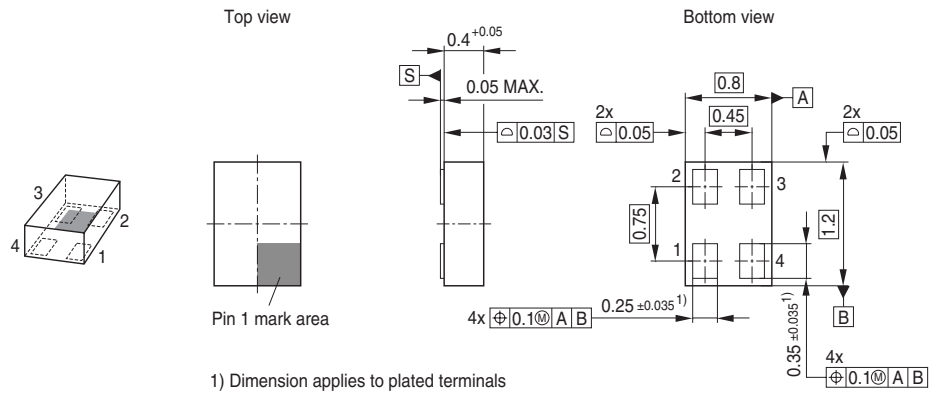


Packing

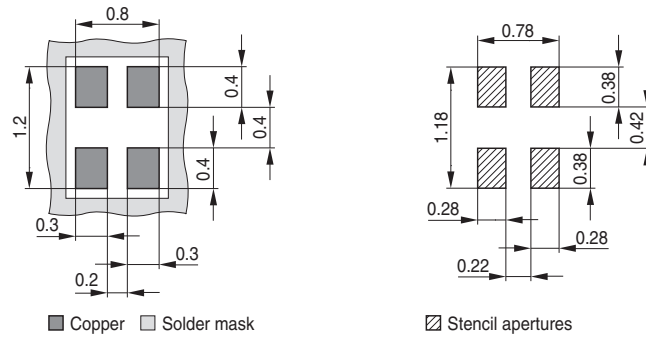
Code E6327: Reel ø180 mm = 15.000 Pieces/Reel



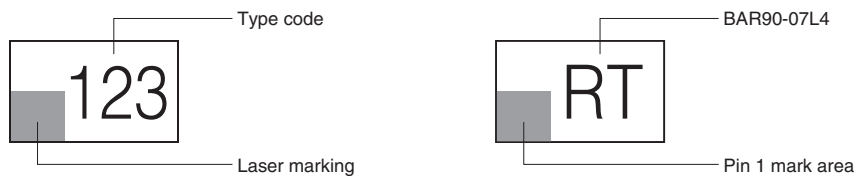
Package Outline



Foot Print



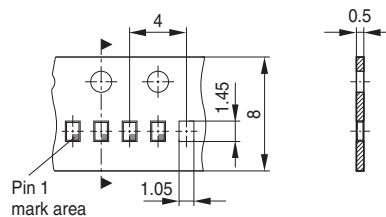
Marking Layout



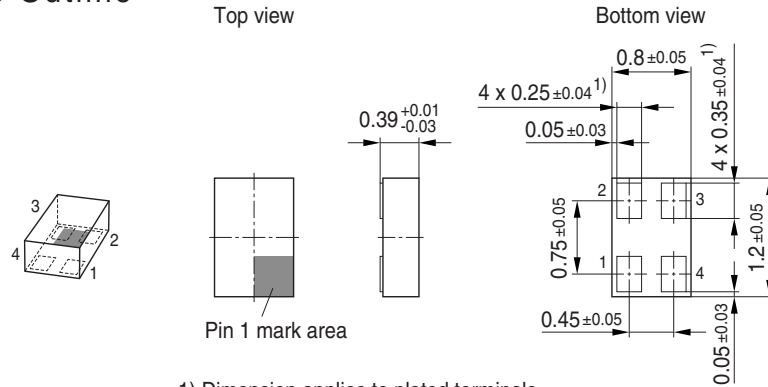
Example

Packing

Code E6327: Reel ø180 mm = 15.000 Pieces/Reel

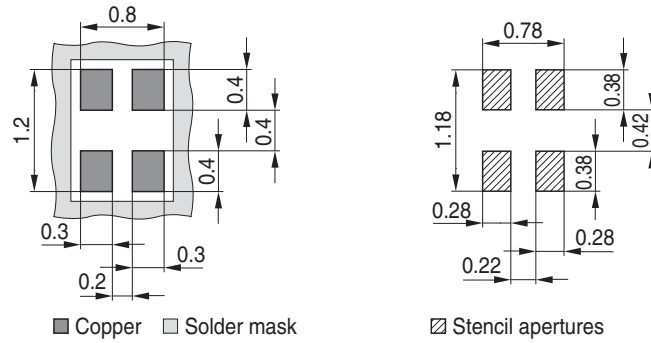


Package Outline

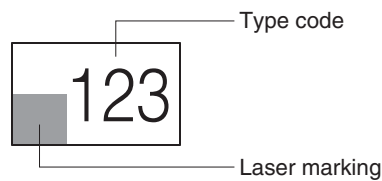


1) Dimension applies to plated terminals

Foot Print

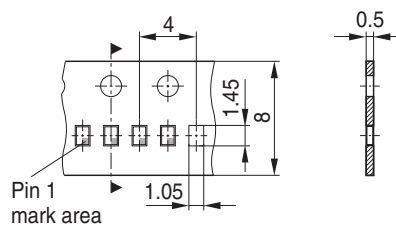


Marking Layout



Packing

Code E6327: Reel ø180 mm = 15.000 Pieces/Reel



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